

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application Of:

Fujio Kuwako

A Division of:

Application No.: 09/229,225

Filed: January 12, 1999

For: METHOD FOR PRODUCING MULTI-LAYER PRINTED WIRING BOARDS HAVING BLIND VIAS

Atty. Docket No.: 47163-00018USD1

Examiner: Not Assigned

Group Art Unit: 1771

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postage prepaid, in an envelope addressed to the Assistant Commissioner for Patents, Attn: Box PATENT APPLICATION, Washington, D.C. 20231, on June 9, 2000.

James P. O'Leary

PRELIMINARY AMENDMENT

Box APPLICATION
Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Before examining this application, please cancel claims 1-9 of the parent application and enter the following amendments.

In the Claims:

Please rewrite claim 10 as follows:

10. (Amended) A multi-layer printed wiring board made by the method [of claim 1] comprising

(a) electrodepositing an alkaline refractory metal which can be dissolved in an acid etching solution on one surface of a copper foil;

(b) applying a thermosetting resin on the electrodeposited alkaline refractory metal of (a) and curing said